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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/670,319	09/26/2003	Martin W. Weiser	H0004362	5332
21567 7590 04/07/2008 WELLS ST. JOHN P.S.			EXAMINER	
601 W. FIRST	AVENUE, SUITE 130	0	NGUYEN, DILINH P	
SPOKANE, WA 99201			ART UNIT	PAPER NUMBER
			2814	
			MAIL DATE	DELIVERY MODE
			04/07/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)		
	10/670,319	WEISER ET AL.		
Office Action Summary	Examiner	Art Unit		
	DILINH NGUYEN	2814		
The MAILING DATE of this communication ap Period for Reply	ppears on the cover sheet with the c	correspondence address		
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING I - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statu Any reply received by the Office later than three months after the mailine earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICATION  .136(a). In no event, however, may a reply be tired will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).		
Status				
Responsive to communication(s) filed on 31 I      This action is <b>FINAL</b> . 2b) ☐ This action is <b>FINAL</b> .      Since this application is in condition for allowed closed in accordance with the practice under	is action is non-final. ance except for formal matters, pro			
Disposition of Claims				
4)  Claim(s) 1-4 and 7-9 is/are pending in the appear 4a) Of the above claim(s) is/are withdra 5)  Claim(s) is/are allowed.  6)  Claim(s) 1-4,7-9 is/are rejected.  7)  Claim(s) is/are objected to.  8)  Claim(s) are subject to restriction and/	awn from consideration.			
Application Papers				
9) The specification is objected to by the Examin 10) The drawing(s) filed on is/are: a) ac Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	cepted or b) objected to by the edrawing(s) be held in abeyance. Section is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).		
Priority under 35 U.S.C. § 119				
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>				
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO/SB/08)  Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:	ate		

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## **DETAILED ACTION**

## Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 12/31/2007 has been entered. A new rejection is made as set forth in this Office Action. Claims 1-4 and 7-9 are pending in the application.

## Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1-2, 4 and 8-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Andricacos et al. (U.S. Pat. 6224690).

Regarding claims 1 and 8-9, Andricacos et al. disclose a semiconductor package comprising a lead-free solder (abstract, column 3, lines 25-29 and column 9, lines 58-65), whereby the lead-free solder ball substantially avoids alpha particle emission (column 9, lines 62-65 and column 10, lines 35-37). The lead-free solder of Andricacos et al. encompasses an alpha flux of less than 0.0005 cts/cm²/hr, an alpha flux of less than 0.0002 cts/cm²/hr or 0.0001 cts/cm²/hr.

Regarding claims 2 and 4, Andicacos et al. disclose the lead-free solder predominately comprises Sn (column 4, lines 19-23).

4. Claims 3 and 7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Andricacos et al. (U.S. Pat. 6224690) in view of Schrock (U.S. Pat. 6221691).

Andricacos et al. substantially disclose all the limitations as claimed above except for the solder predominately comprises Ag, Bi, Cu or In.

However, Schrock discloses a semiconductor substrate comprising a die 10, a substrate 22, a solder predominately comprises Ag (column 2, lines 5-10). Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have the solder predominately comprises Ag as taught by Schrock into the device structure of Andricacos et al. in order to improve the heat transfer from the die (column 2, lines 9-10).

Regarding claim 7, Schrock discloses the solder predominately comprises In [63%In/37%Sn] (column 4, lines 4-5).

## Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DILINH NGUYEN whose telephone number is (571)272-1712. The examiner can normally be reached on 8:00AM - 5:00PM (M-F).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

DLN

/Theresa T. Doan/ Primary Examiner, Art Unit 2814